

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**Industrial communication networks – Profiles –
Part 1: Fieldbus profiles**

**Réseaux de communication industriels – Profils –
Partie 1: Profils de bus de terrain**



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INTERNATIONAL ELECTROTECHNICAL COMMISSION

**INDUSTRIAL COMMUNICATION NETWORKS –
PROFILES –****Part 1: Fieldbus profiles**

FOREWORD

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NOTE Combinations of protocol types are specified in IEC 61784-1 and IEC 61784-2.

International Standard IEC 61784-1 has been prepared by subcommittee 65C: Industrial networks, of IEC technical committee 65: Industrial-process measurement, control and automation.

This fourth edition cancels and replaces the third edition published in 2010. This edition constitutes a technical revision.

The main changes with respect to the previous edition are listed below:

- update of the dated references to the IEC 61158 series, to IEC 61784-2, to the IEC 61784-3 series, to the IEC 61784-5 series and to IEC 61918 throughout the document;
- new profile family CPF 19;
- update of selection tables for CPF 1 and CPF 9.

The text of this standard is based on the following documents:

FDIS	Report on voting
65C/760/FDIS	65C/770/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts of the IEC 61784 series, published under the general title *Industrial communication networks – Profiles*, can be found on the IEC web site.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

IMPORTANT – The 'colour inside' logo on the cover page of this publication indicates that it contains colours which are considered to be useful for the correct understanding of its contents. Users should therefore print this document using a colour printer.

INTRODUCTION

This part of IEC 61784 provides a set of Communication Profiles (CP) in the sense of ISO/IEC TR 10000-1. These answer the need of identifying the protocol families co-existing within the IEC 61158 series, as a result of the international harmonization of fieldbus technologies available on the market. More specifically, these profiles help to correctly state the compliance to the IEC 61158 series, and to avoid the spreading of divergent implementations, which would limit its use, clearness and understanding. Additional profiles to address specific market concerns, such as functional safety or information security, may be addressed by future parts of this standard.

This standard contains several Communication Profile Families (CPF), which specify one or more communication profiles. Such profiles identify, in a strict sense, protocol subsets of the IEC 61158 series via protocol specific communication profiles. They do not define device-type-specific communication profiles for the purpose of guiding manufacturers in feature set selection – for example, in selecting the minimum set of communication services and protocol to implement a specific class of devices, such as generic slaves or transmitters ("implementation profiles"). Neither do they define device profiles that specify communication profiles together with application functions needed to answer the need of a specific application ("application profiles").

It is agreed that these latter classes of profiles would help the use of the IEC 61158 series of standards; the profiles defined in this document are a necessary step to achieve that task.

It is also important to clarify that interoperability – defined as the ability of two or more network systems to exchange information and to make mutual use of the information that has been exchanged (see 3.2.1 of ISO/IEC TR 10000-1) – can be directly achieved on the same link only for those devices complying to the same communication profile.

Profiles contained in this International Standard are constructed of references to IEC 61158-2 and the IEC 61158-3, IEC 61158-4, IEC 61158-5 and IEC 61158-6 series, and other IS, TS or worldwide-accepted standards, as appropriate¹. Each profile is required to reference at least one (sub)part of IEC 61158-2 through IEC 61158-6.

Two or more Profiles, which are related to a common family, are specified within a "Communication Profile Family" (CPF).

¹ International Standardised Profiles may contain normative references to specifications other than International Standards; see ISO/IEC JTC 1 N 4047.

INDUSTRIAL COMMUNICATION NETWORKS – PROFILES –

Part 1: Fieldbus profiles

1 Scope

This part of IEC 61784 defines a set of protocol specific communication profiles based primarily on the IEC 61158 series, to be used in the design of devices involved in communications in factory manufacturing and process control.

Each profile selects specifications for the communications protocol stack at a device. It contains a minimal set of required services at the application layer and specification of options in intermediate layers defined through references. If no application layer is included, then a minimal set of required services at the Data-link layer is specified. The appropriate references to the protocol specific types are given in each communication profile family or associated profiles.

NOTE All profiles are based on standards or draft standards or International Standards published by the IEC or from standards or International Standards established by other standards bodies or open standards processes.

The structure of communication profile families is specified in Figure 1.

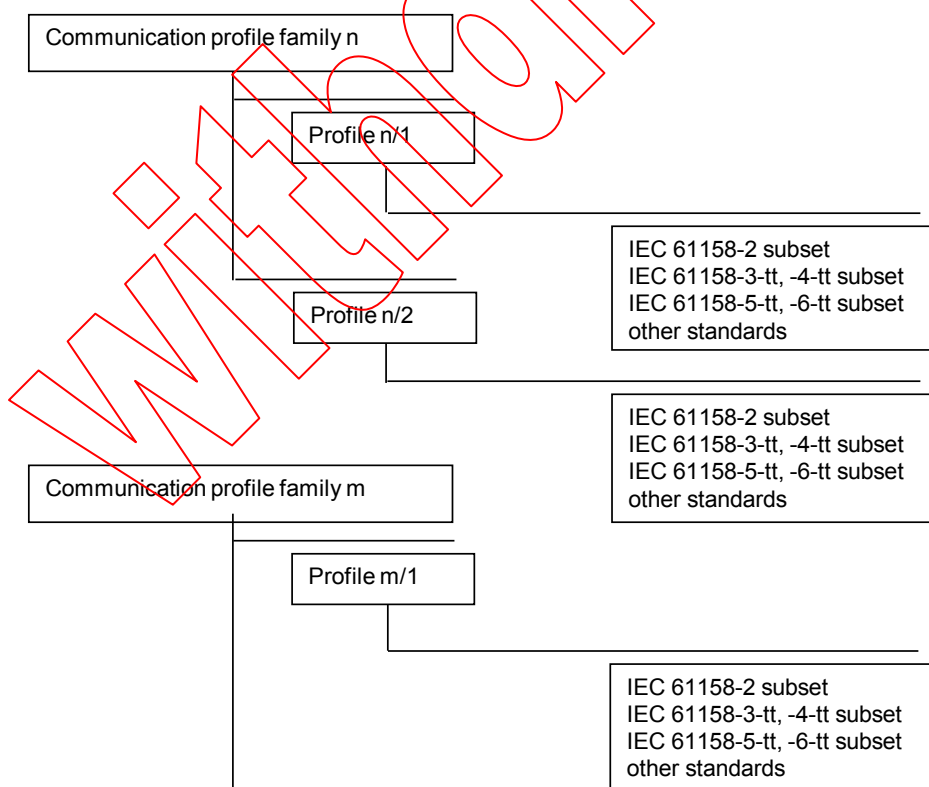


Figure 1 – Communication profile families and profiles

Each profile selects an appropriate consistent and compatible subset of services and protocols from the total available set that is defined and modeled in IEC 61158. For the

selected subset of services and protocols, the profile also describes any possible or necessary constraints in parameter values.

Table 1 shows the communication profile families that are defined in this standard.

Table 1 – Relations of Communication Profile Families to type numbers

IEC 61784-1 contents			Corresponding IEC 61158 Types
CPF	Clause	Communication Profile Families (Note 1)	Type
1	5	Foundation® Fieldbus	1, 5, 9 (see Note 2)
2	6	CIP™	2
3	7	PROFIBUS & PROFINET	3 (see Note 3)
4	8	P-NET®	4
5	9	WorldFIP®	7
6	10	INTERBUS®	8
7	11	Has been removed based for lack of market relevance	6
8	12	CC-Link	18
9	13	HART	20
16	14	SERCOS	16
19	15	MECHATROLINK	24

NOTE 1 See the specific CPF clauses for information on the respective trademark holders.

NOTE 2 CP 1/1 has a denigrated PhL device profile subclass, which uses a variant of a Type 3 PhL.

NOTE 3 CP 3/2 has a denigrated PhL device profile subclass, which uses a variant of a Type 1 PhL.

NOTE 4 Other CPFs can be found in IEC 61784-2.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE All parts of the IEC 61158 series, as well as IEC 61784-1 and IEC 61784-2 are maintained simultaneously. Cross-references to these documents within the text therefore refer to the editions as dated in this list of normative references.

IEC 60079-11, *Explosive atmospheres – Part 11: Equipment protection by intrinsic safety "i"*

IEC 60079-25, *Explosive atmospheres – Part 25: Intrinsically safe electrical systems*

IEC 61010 (all parts), *Safety requirements for electrical equipment for measurement, control and laboratory use*

IEC 61131-2, *Programmable controllers – Part 2: Equipment requirements and tests*

IEC 61158 (all parts), *Industrial communication networks – Fieldbus specifications*

IEC 61158-2:2014, *Industrial communication networks – Fieldbus specifications – Part 2: Physical layer specification and service definition*

IEC 61158-3-1:2014, *Industrial communication networks – Fieldbus specifications – Part 3-1: Data-link layer service definition – Type 1 elements*

IEC 61158-3-2:2014, *Industrial communication networks – Fieldbus specifications – Part 3-2: Data-link layer service definition – Type 2 elements*

IEC 61158-3-3:2014, *Industrial communication networks – Fieldbus specifications – Part 3-3: Data-link layer service definition – Type 3 elements*

IEC 61158-3-4:2014, *Industrial communication networks – Fieldbus specifications – Part 3-4: Data-link layer service definition – Type 4 elements*

IEC 61158-3-7:2007, *Industrial communication networks – Fieldbus specifications – Part 3-7: Data-link layer service definition – Type 7 elements*

IEC 61158-3-8:2007, *Industrial communication networks – Fieldbus specifications – Part 3-8: Data-link layer service definition – Type 8 elements*

IEC 61158-3-16:2007, *Industrial communication networks – Fieldbus specifications – Part 3-16: Data-link layer service definition – Type 16 elements*

IEC 61158-3-18:2007, *Industrial communication networks – Fieldbus specifications – Part 3-18: Data-link layer service definition – Type 18 elements*

IEC 61158-3-19:2014, *Industrial communication networks – Fieldbus specifications – Part 3-19: Data-link layer service definition – Type 19 elements*

IEC 61158-3-20:2014, *Industrial communication networks – Fieldbus specifications – Part 3-20: Data-link layer service definition – Type 20 elements*

IEC 61158-3-24:2014, *Industrial communication networks – Fieldbus specifications – Part 3-24: Data-link layer service definition – Type 24 elements*

IEC 61158-4-1:2014, *Industrial communication networks – Fieldbus specifications – Part 4-1: Data-link layer protocol specification – Type 1 elements*

IEC 61158-4-2:2014, *Industrial communication networks – Fieldbus specifications – Part 4-2: Data-link layer protocol specification – Type 2 elements*

IEC 61158-4-3:2014, *Industrial communication networks – Fieldbus specifications – Part 4-3: Data-link layer protocol specification – Type 3 elements*

IEC 61158-4-4:2014, *Industrial communication networks – Fieldbus specifications – Part 4-4: Data-link layer protocol specification – Type 4 elements*

IEC 61158-4-7:2007, *Industrial communication networks – Fieldbus specifications – Part 4-7: Data-link layer protocol specification – Type 7 elements*

IEC 61158-4-8:2007, *Industrial communication networks – Fieldbus specifications – Part 4-8: Data-link layer protocol specification – Type 8 elements*

IEC 61158-4-16:2007, *Industrial communication networks – Fieldbus specifications – Part 4-16: Data-link layer protocol specification – Type 16 elements*

IEC 61158-4-18:2010, *Industrial communication networks – Fieldbus specifications – Part 4-18: Data-link layer protocol specification – Type 18 elements*

IEC 61158-4-19:2014, *Industrial communication networks – Fieldbus specifications – Part 4-19: Data-link layer protocol specification – Type 19 elements*

IEC 61158-4-20:2014, *Industrial communication networks – Fieldbus specifications – Part 4-20: Data-link layer protocol specification – Type 20 elements*

IEC 61158-4-24:2014, *Industrial communication networks – Fieldbus specifications – Part 4-24: Data-link layer protocol specification – Type 24 elements*

IEC 61158-5-2:2014, *Industrial communication networks – Fieldbus specifications – Part 5-2: Application layer service definition – Type 2 elements*

IEC 61158-5-3:2014, *Industrial communication networks – Fieldbus specifications – Part 5-3: Application layer service definition – Type 3 elements*

IEC 61158-5-4:2014, *Industrial communication networks – Fieldbus specifications – Part 5-4: Application layer service definition – Type 4 elements*

IEC 61158-5-5:2014, *Industrial communication networks – Fieldbus specifications – Part 5-5: Application layer service definition – Type 5 elements*

IEC 61158-5-7:2007, *Industrial communication networks – Fieldbus specifications – Part 5-7: Application layer service definition – Type 7 elements*

IEC 61158-5-8:2007, *Industrial communication networks – Fieldbus specifications – Part 5-8: Application layer service definition – Type 8 elements*

IEC 61158-5-9:2014, *Industrial communication networks – Fieldbus specifications – Part 5-9: Application layer service definition – Type 9 elements*

IEC 61158-5-16:2007, *Industrial communication networks – Fieldbus specifications – Part 5-16: Application layer service definition – Type 16 elements*

IEC 61158-5-18:2010, *Industrial communication networks – Fieldbus specifications – Part 5-18: Application layer service definition – Type 18 elements*

IEC 61158-5-19:2014, *Industrial communication networks – Fieldbus specifications – Part 5-19: Application layer service definition – Type 19 elements*

IEC 61158-5-20:2014, *Industrial communication networks – Fieldbus specifications – Part 5-20: Application layer service definition – Type 20 elements*

IEC 61158-5-24:2014, *Industrial communication networks – Fieldbus specifications – Part 5-24: Application layer service definition – Type 24 elements*

IEC 61158-6-2:2014, *Industrial communication networks – Fieldbus specifications – Part 6-2: Application layer protocol specification – Type 2 elements*

IEC 61158-6-3:2014, *Industrial communication networks – Fieldbus specifications – Part 6-3: Application layer protocol specification – Type 3 elements*

IEC 61158-6-4:2014, *Industrial communication networks – Fieldbus specifications – Part 6-4: Application layer protocol specification – Type 4 elements*

IEC 61158-6-5:2014, *Industrial communication networks – Fieldbus specifications – Part 6-5: Application layer protocol specification – Type 5 elements*

IEC 61158-6-7:2007, *Industrial communication networks – Fieldbus specifications – Part 6-7: Application layer protocol specification – Type 7 elements*

IEC 61158-6-8:2007, *Industrial communication networks – Fieldbus specifications – Part 6-8: Application layer protocol specification – Type 8 elements*

IEC 61158-6-9:2014, *Industrial communication networks – Fieldbus specifications – Part 6-9: Application layer protocol specification – Type 9 elements*

IEC 61158-6-16:2007, *Industrial communication networks – Fieldbus specifications – Part 6-16: Application layer protocol specification – Type 16 elements*

IEC 61158-6-18:2010, *Industrial communication networks – Fieldbus specifications – Part 6-18: Application layer protocol specification – Type 18 elements*

IEC 61158-6-19:2014, *Industrial communication networks – Fieldbus specifications – Part 6-19: Application layer protocol specification – Type 19 elements*

IEC 61158-6-20:2014, *Industrial communication networks – Fieldbus specifications – Part 6-20: Application layer protocol specification – Type 20 elements*

IEC 61158-6-24:2014, *Industrial communication networks – Fieldbus specifications – Part 6-24: Application layer protocol specification – Type 24 elements*

IEC 61784-2:2014, *Industrial communication networks – Profiles – Part 2: Additional fieldbus profiles for real-time networks based on ISO/IEC 8802-3*

IEC 61784-5-2:2013, *Industrial communication networks – Profiles – Part 5-2: Installation of fieldbuses – Installation profiles for CPF 2*

IEC 61918:2013, *Industrial communication networks – Installation of communication networks in industrial premises*

IEC 62026-3, *Low-voltage switchgear and controlgear – Controller-device interfaces (CDIs) – Part 3: DeviceNet*

IEC 62591:2010, *Industrial communication networks – Wireless communication network and communication profiles – WirelessHART™*

ISO/IEC 8482, *Information technology – Telecommunications and information exchange between systems – Twisted pair multipoint interconnections*

ISO/IEC 8802-2:1998, *Information technology – Telecommunications and information exchange between systems – Local and metropolitan area networks – Specific requirements – Part 2: Logical link control*

ISO/IEC 8802-3:2000, *Information technology – Telecommunications and information exchange between systems – Local and metropolitan area networks – Specific requirements – Part 3: Carrier sense multiple access with collision detection (CSMA/CD) access method and physical layer specifications*

ISO/IEC 15802-3, *Information technology – Telecommunications and information exchange between systems – Local and metropolitan area networks – Common specifications – Part 3: Media Access Control (MAC) Bridges*

ISO 15745-3:2003, *Industrial automation systems and integration – Open systems application integration framework – Part 3: Reference description for IEC 61158-based control systems*

ISO 15745-4:2003, *Industrial automation systems and integration – Open systems application integration framework – Part 4: Reference description for Ethernet-based control systems, Amendment 1:2006, PROFINET profiles*

ANSI TIA/EIA-485-A:1998, *Electrical Characteristics of Generators and Receivers for Use in Balanced Digital Multipoint Systems*

IEEE 802.3-2002, *IEEE Standard for Information technology – Telecommunications and information exchange between systems – Local and metropolitan area networks – Specific requirements – Part 3: Carrier Sense Multiple Access with Collision Detection (CSMA/CD) Access Method and Physical Layer Specifications*

IETF RFC 768, *User Datagram Protocol*; available at <<http://www.ietf.org>>

IETF RFC 791, *Internet Protocol*; available at <<http://www.ietf.org>>

IETF RFC 792, *Internet Control Message Protocol*; available at <<http://www.ietf.org>>

IETF RFC 793, *Transmission Control Protocol*; available at <<http://www.ietf.org>>

IETF RFC 826, *Ethernet Address Resolution Protocol*; available at <<http://www.ietf.org>>

IETF RFC 894, *A standard for the Transmission of IP Datagrams over Ethernet Networks*; available at <<http://www.ietf.org>>

IETF RFC 1112, *Host Extensions for IP Multicasting*; available at <<http://www.ietf.org>>

IETF RFC 1122, *Requirements for Internet Hosts – Communication Layers*; available at <<http://www.ietf.org>>

IETF RFC 1123, *Requirements for Internet Hosts – Application and Support*; available at <<http://www.ietf.org>>

IETF RFC 1127, *A Perspective on the Host Requirements RFCs*; available at <<http://www.ietf.org>>

IETF RFC 2236, *Internet Group Management Protocol, Version 2*; available at <<http://www.ietf.org>>

3 Definitions

3.1 Terms and definitions

For the purposes of this document, all terms and definitions provided in the IEC 61158 series apply.

3.2 Abbreviations and symbols

3.2.1 IEC 61158 abbreviations and symbols

For the purposes of this profile, all abbreviations and symbols defined in the IEC 61158 series apply. The following abbreviations, found within the IEC 61158 series, are repeated here for

use by those who wish to understand the general structure of this International Standard without referring to the IEC 61158 series.

AL	Application layer
APDU	Application protocol data unit
AR	Application relationship
ASE	Application service element
DL-	Data-link layer (as a prefix)
DLL	Data-link layer
DLSDU	Data-link service data unit
PhL	Physical layer
TPDU	Transport protocol data unit

3.2.2 Other abbreviations and symbols

CE	“Conformité Européene” (i.e., “European Conformity”)
CP	communication profile
CPF	communication profile family
DP-V0	PROFIBUS DP version 0
DP-V1	PROFIBUS DP version 1
EMC	electro-magnetic compatibility
IDN	identification number
IP	internet protocol
IS	intrinsically safe (as an adjective) intrinsic safety (as a noun)
ISP	international standardized profiles
IV	initialization vector
MAU	medium attachment unit
PPDU	presentation protocol data unit
RS 485	MAU according to ANSI TIA/EIA-485-A
RS 485-IS	MAU according to ANSI TIA/EIA-485-A and applicable to IS
TCP	terminal control protocol
UDP	user datagram protocol

3.3 Conventions

3.3.1 Conventions common to all layers

3.3.1.1 (Sub)clause selection tables

(Sub)clause selection for all layers is defined in tables, as shown in Table 2 and Table 3. The selected base specifications are indicated just before the selection table(s). Selection is done at the highest (sub)clause level possible to define the profile selection unambiguously.

Table 2 – Layout of profile (sub)clause selection tables

Clause	Header	Presence	Constraints

Table 3 – Contents of (sub)clause selection tables

Column	Text	Meaning
Clause	<#>	(sub)clause number of the base specifications
	Next clauses	any following clauses up to the last clause of the base specification
	Next Annexes	any following annexes up to the last annex of the base specification
Header	<text>	(sub)clause title of the base specifications
Presence	NO	This (sub)clause is not included in the profile
	YES	This (sub)clause is fully (100 %) included in the profile in this case no further detail is given
	—	Presence is defined in the following subclauses
	Partial	Parts of this (sub)clause is included in the profile
Constraints	See <#>	Constraints/remarks are defined in the given subclause, table or figure of this profile document
	—	No constraints other than given in the reference document (sub)clause, or not applicable
	<text>	The text defines the constraint directly, for longer text table footnotes or table notes may be used

If sequences of (sub)clauses do not match the profile, then the numbers are concatenated.

EXAMPLE 1 Concatenated subclauses

3.4 – 3.7	—	NO	—
-----------	---	----	---

EXAMPLE 2 Concatenated clauses up to the last clause

Next clauses	—	NO	—
--------------	---	----	---

EXAMPLE 3 concatenated annexes up to the last annex

Next annexes	—	NO	—
--------------	---	----	---

3.3.1.2 Service selection tables

If selection of services is defined in a table the format of Table 4 is used. The table identifies the selected services and includes service constraints, as explained in Table 5.

Table 4 – Layout of service selection tables

Service ref.	Service name	Usage	Constraint

Table 5 – Contents of service selection tables

Column	Text	Meaning
Service ref.	<#>	(sub)clause number of the base specifications where the service is defined
	—	Not applicable
Service name	<text>	The name of the service
Usage	M	Mandatory
	O	Optional
	—	Service is never used
Constraints	See <#>	Constraints/remarks are defined in the given subclause, table or figure of this profile document
	—	No constraints other than given in the reference document (sub)clause, or not applicable
	<text>	The text defines the constraint directly, for longer text table footnotes or table notes may be used

If selection of service parameters is defined in a table the format of Table 6 is used. Each table identifies the selected parameters and includes parameter constraints, as explained in Table 7.

Table 6 – Layout of parameter selection tables

Parameter ref.	Parameter name	Usage	Constraint

Table 7 – Contents of parameter selection tables

Column	Text	Meaning
Parameter ref.	<#>	(sub)clause number of the base specifications where the service is defined
	—	Not applicable
Parameter name	<text>	The name of the service parameter
Usage	M	Mandatory
	O	Optional
	—	Attribute is never present
Constraints	See <#>	Constraints/remarks are defined in the given subclause, table or figure of this profile document
	—	No constraints other than given in the reference document (sub)clause, or not applicable
	<text>	The text defines the constraint directly, for longer text table footnotes or table notes may be used

3.3.2 Physical layer

No additional conventions are defined.

3.3.3 Data-link layer

3.3.3.1 Service profile conventions

No additional conventions are defined.

3.3.3.2 Service and parameter selections

These are described using the common conventions, see 3.3.1.2.

3.3.4 Application layer

3.3.4.1 Service profile conventions

ASE and class selection is described using (sub)clause selection tables, see 3.3.1.1. If the usage of selected ASE and classes is further constrained this is specified in the profile (e.g. an optional item of the base standard is mandatory in the profile).

If selection of class attributes is defined in a table the format of Table 8 is used. The table identifies the selected class attributes and includes their constraints, as explained in Table 9.

Table 8 – Layout of class attribute selection tables

Attribute	Attribute Name	Usage	Constraint

Table 9 – Contents of class attribute selection tables

Column	Text	Meaning
Attribute	<#>	Attribute number of the base specification class
	—	Not applicable
Attribute Name	<text>	The name of the attribute
Usage	M	Mandatory
	O	Optional
	—	Attribute is never present
Constraints	See <#>	Constraints/remarks are defined in the given subclause, table or figure of this profile document
	—	No constraints other than given in the reference document (sub)clause, or not applicable
	<text>	The text defines the constraint directly, for longer text table footnotes or table notes may be used

3.3.4.2 Service and parameter selections

These are described using the common conventions, see 3.3.1.2.

4 Conformance to communication profiles

Each communication profile within this International Standard includes part of the IEC 61158 series. It may also include parts of other standards or international specifications.

A statement of compliance to a Communication Profile Family (CPF) of this International Standard shall be stated² as either

² In accordance with ISO/IEC Directives